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APPLICATION N	0.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/944,463 08/30/2001		08/30/2001	Richard Regner	10829-8540US	2840
25096	7590	02/23/2004		EXAMINER	
PERKINS COIE LLP				YAN, REN LUO	
PATENT P.O. BOX			ART UNIT	PAPER NUMBER	
SEATTLE, WA 98111-1247				2854	
				DATE MAILED: 02/23/2004	

Please find below and/or attached an Office communication concerning this application or proceeding.

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	Application No.	Applicant(s)	
Advisory Action	09/944,463	REGNER ET AL.	
,	Examiner	Art Unit	
	Ren L Yan	2854	
The MAILING DATE of this communication appe	ars on the cover sheet with the c	orrespondence address	
THE REPLY FILED 29 January 2004 FAILS TO PLACE Therefore, further action by the applicant is required to a final rejection under 37 CFR 1.113 may only be either: (1 condition for allowance; (2) a timely filed Notice of Appetexamination (RCE) in compliance with 37 CFR 1.114.	void abandonment of this applice i) a timely filed amendment whi	cation. A proper reply to a ch places the application in	
PERIOD FOR RE	PLY [check either a) or b)]		
a) The period for reply expires <u>3</u> months from the mailing date of	-		
b) The period for reply expires on: (1) the mailing date of this Adv event, however, will the statutory period for reply expire later the ONLY CHECK THIS BOX WHEN THE FIRST REPLY WAS 706.07(f).	an SIX MONTHS from the mailing date of	f the final rejection.	
Extensions of time may be obtained under 37 CFR 1.136(a). The dathave been filed is the date for purposes of determining the period of extens 37 CFR 1.17(a) is calculated from: (1) the expiration date of the shortened (b) above, if checked. Any reply received by the Office later than three moleaned patent term adjustment. See 37 CFR 1.704(b).	sion and the corresponding amount of the statutory period for reply originally set in	fee. The appropriate extension fee under the final Office action; or (2) as set forth in	n
1. A Notice of Appeal was filed on Appellant's 37 CFR 1.192(a), or any extension thereof (37 CF	-		
2. \square The proposed amendment(s) will not be entered be	ecause:		
(a) they raise new issues that would require further	er consideration and/or search (see NOTE below);	
(b) they raise the issue of new matter (see Note b	pelow);		
(c) they are not deemed to place the application i issues for appeal; and/or	n better form for appeal by mat	erially reducing or simplifying the	те
(d) \square they present additional claims without cancel	ing a corresponding number of	finally rejected claims.	
NOTE:			
3. Applicant's reply has overcome the following rejection.			
4. Newly proposed or amended claim(s) would canceling the non-allowable claim(s).	be allowable if submitted in a s	eparate, timely filed amendmen	t
5. ☐ The a) ☐ affidavit, b) ☐ exhibit, or c) ☐ request fo application in condition for allowance because: Se		sidered but does NOT place the	
6. The affidavit or exhibit will NOT be considered be raised by the Examiner in the final rejection.	cause it is not directed SOLELY	to issues which were newly	
7. For purposes of Appeal, the proposed amendment explanation of how the new or amended claims we			
The status of the claim(s) is (or will be) as follows:			
Claim(s) allowed: 1-13 and 20-81.			
Claim(s) objected to: 19.			
Claim(s) rejected: 14-18.	•		
Claim(s) withdrawn from consideration:			
8. The drawing correction filed on is a) app	roved or b) disapproved by	the Examiner.	
9. Note the attached Information Disclosure Stateme	nt(s)(PTO-1449) Paper No(s).		
10. Other:		Ren yan	
		Ren L Yan Primary Examiner Art Unit: 2854	

Continuation Sheet (PTOL-303) 09/944,463

Continuation of 5. does NOT place the application in condition for allowance because: the structure of the soldering stencil of claim 14 is met by the applied patent to Amir and the electronic components do not form any part of the soldering stencil as claimed. Further more, the stencil of Amir is well capable of being used to print soldering patterns for the same single component type as recited .